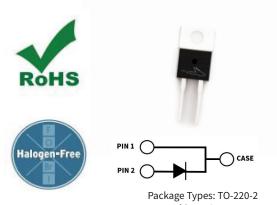


3rd Generation 600 V, 2 A Silicon Carbide Schottky Diode

Description

With the performance advantages of a Silicon Carbide (SiC) Schottky Barrier diode, power electronics systems can expect to meet higher efficiency standards than Si-based solutions, while also reaching higher frequencies and power densities. SiC diodes can be easily paralleled to meet various application demands, without concern of thermal runaway. In combination with the reduced cooling requirements and improved thermal performance of SiC products, SiC diodes are able to provide lower overall system costs in a variety of diverse applications.



Marking: C3D02060A

Features

- Low Forward Voltage (V_F) Drop with Positive **Temperature Coefficient**
- Zero Reverse Recovery Current / Forward Recovery Voltage
- Temperature-Independent Switching Behavior

Applications

- **Industrial Switched Mode Power Supplies**
- Uninterruptible & AUX Power Supplies
- Boost for PFC & DC-DC Stages
- **Solar Inverters**

Maximum Ratings (T_c = 25°C Unless Otherwise Specified)

Parameter	Symbol	Value	Unit	Test Conditions	Notes	
Repetitive Peak Reverse Voltage	V _{RRM}	600				
DC Blocking Voltage	V _{DC}	600	V			
		8		T _J = 25 °C		
Continuous Forward Current	I _F	4		T _J = 135 °C	Fig. 3	
		2		T _J = 161 °C		
Repetitive Peak Forward Surge		11		$T_c = 25$ °C, $t_p = 10$ ms, Half Sine Wave		
Current	FRM	7.5	Α	$T_c = 110 ^{\circ}\text{C}, t_p = 10 \text{ms}, \text{Half Sine Wave}$		
Non-Repetitive Forward Surge Current	 FSM	16.5		T _c = 25 °C, t _p = 10 ms, Half Sine Wave	F:- 0	
		15		$T_c = 110 ^{\circ}\text{C,t}_p = 10 \text{ms, Half Sine Wave}$	Fig. 8	
Non-Repetitive Peak Forward		120		T _c = 25 °C, t _p = 10 μs, Pulse		
Surge Current	F,Max	110		T _c = 110°C, t _p = 10 μs, Pulse		
Power Dissipation	P _{tot}	39.5	W	T _J = 25 °C	Fig. 4	
		17		T _J = 110 °C		
i²t value	ʃi²dt	1.35	A²s	$T_c = 25 ^{\circ}\text{C}, t_p = 10 \text{ms}$		
		1.12		$T_{c} = 110 {}^{\circ}\text{C}, \ t_{p} = 10 \text{ms}$		

Electrical Characteristics

Parameter	Symbol	Тур.	Max.	Unit	Test Conditions	Notes
Forward Voltage		1.5	1.7	V	I _F = 2 A, T _j = 25 °C	Fig. 1
	V _F	1.8	2.4		I _F = 2 A, T _j = 175 °C	
Reverse Current		3	15	μА	$V_R = 600 \text{ V}, T_j = 25 \text{ °C}$	Fig. 2
	I _R	6	55		$V_R = 600 \text{ V}, T_j = 175 \text{ °C}$	
Total Capacitive Charge	Q _c	5.8		nC	$V_R = 400 \text{ V}, T_j = 25 \text{ °C}$	Fig. 5
		175			$V_R = 0 \text{ V}, T_j = 25 \text{ °C}, f = 1 \text{ MHz}$	
Total Capacitance	c	10.5		pF	$V_R = 200 \text{ V}, T_j = 25 \text{ °C}, f = 1 \text{ MHz}$	Fig. 6
		8.5			$V_R = 400 \text{ V}, T_j = 25 \text{ °C}, f = 1 \text{ MHz}$	
Capacitance Stored Energy	E _c	0.8		μJ	V _R = 400 V	Fig. 7

Notes:

SiC Schottky Diodes are majority carrier devices, so there is no reverse recovery charge.

Thermal & Mechanical Characteristics

Parameter	Symbol	Value	Unit	Notes
Thermal Resistance, Junction to Case (Typical)	R _{0, JC (TYP)}	3.8	°C/W	
Junction Temperature	T _j	-55 to +175	°C	
Case & Storage Temperature	T _c	-55 to +175		
		1	Nm	M3 Screw
TO-220 Mounting Torque	-	8.8	lbf-in	6-32 Screw

Electrostatic Discharge (ESD) Classifications

Parameter	Symbol	Notes
Human Body Model	НВМ	Class 3B (≥ 8000 V)
Charge Device Model	CDM	Class C3 (≥ 1000 V)

Typical Performance

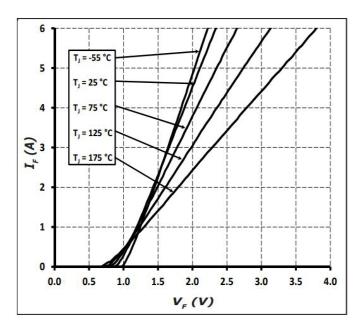


Figure 1Forward Characteristics

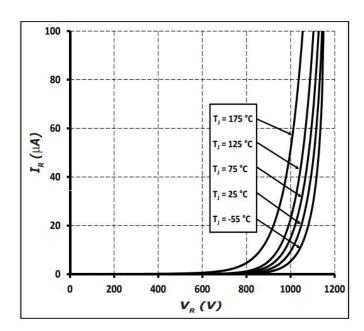


Figure 2Reverse Characteristics

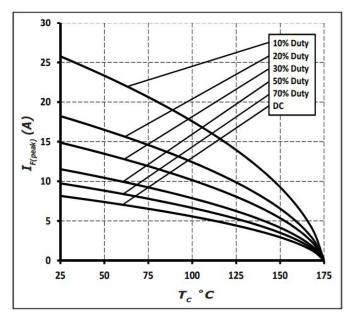


Figure 3Current Derating

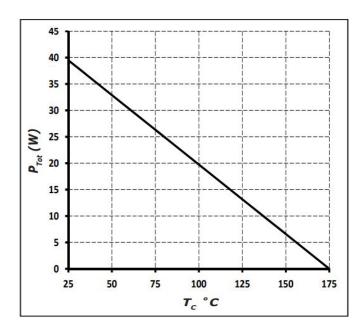


Figure 4Power Derating

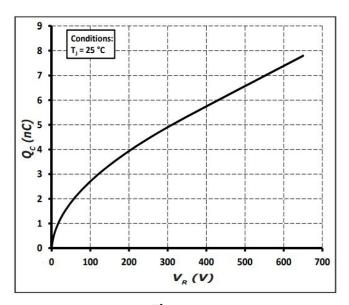


Figure 5Total Capacitance vs. Reverse Voltage

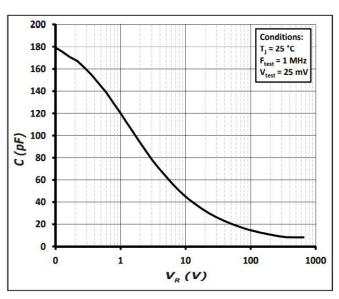


Figure 6Capacitace vs. Reverse Voltage

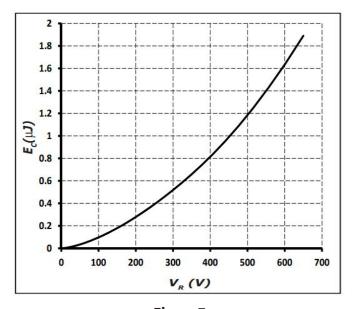


Figure 7Capacitance Stored Energy

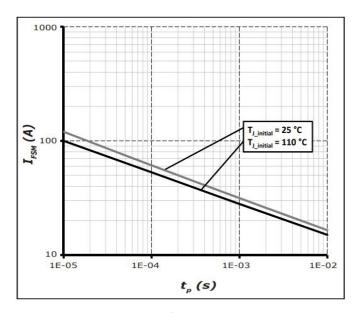


Figure 8Non-Repetitive Peak Forward Surge Current versus Pulse Duration (sinusoidal waveform)

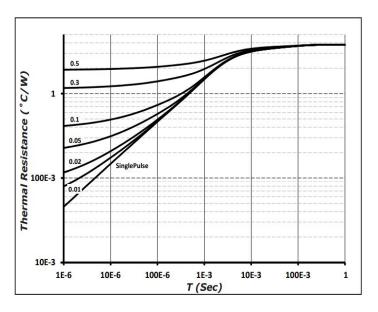


Figure 9Transient Thermal Impedance

Diode Model

$$\begin{array}{c|c} - & & \\ \hline V_T & R_T \\ \end{array}$$

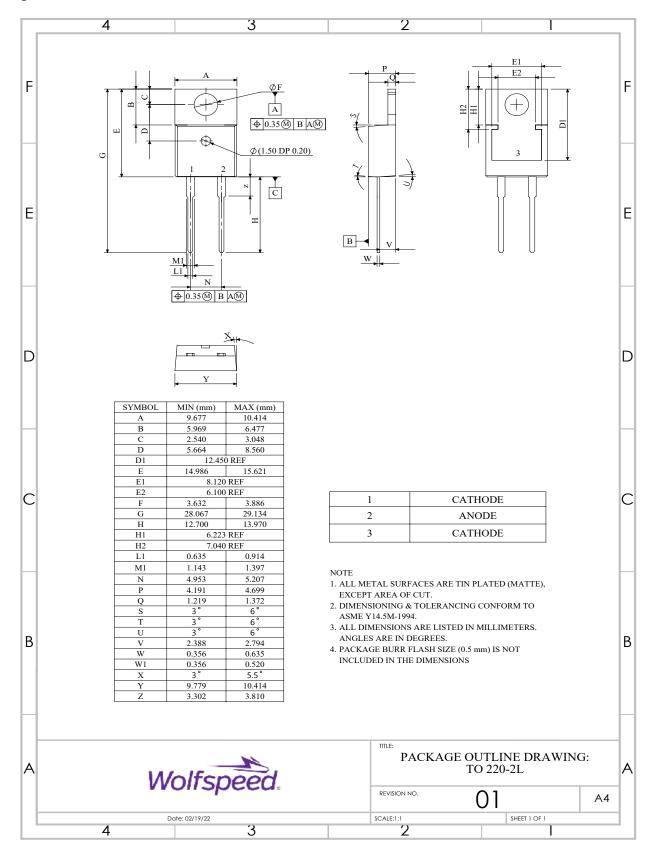
$$Vf_T = V_T + If^*R_T$$

$$\begin{aligned} V_{T=} &\, 0.94 + (T_j * -1.2*10^{-3}) \\ R_{T=} &\, 0.015 + (T_j * 6.4*10^{-3}) \end{aligned}$$

Note: T_{j} = Diode Junction Temperature In Degrees Celsius

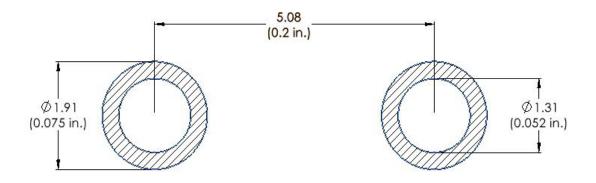
Package Dimensions & Pin-Out

Package: TO-220-2



Recommended Solder Pad Layout

Primary dimensions shown in mm. Learn more about recommended soldering profiles in this application note.



Product Ordering Information

Order Number	Packing Type	
C3D02060A	Tube	

Learn more about power device packing & shipment information in this application note.

Revision History

Document Version	Date of Release	Description of Changes
1	October-2016	Initial Release
8	March-2023	Update Package Drawing Update Landing Pad

302060A

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